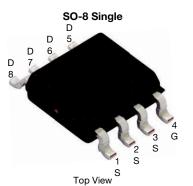
Si4835DDY

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PRODUCT SUMMARY					
V _{DS} (V)	-30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.018				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.030				
Q _g typ. (nC)	22				
I _D (A) ^d	-13				
Configuration	Single				

FEATURES

P-Channel 30 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Load switches
- Notebook PCs
- Desktop PCs



P-Channel MOSFET

GC

PRODUCT SUMMARY					
V _{DS} (V)	-30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.018				
$R_{DS(on)}$ max. (Ω) at V_GS = -4.5 V	0.030				
Q _g typ. (nC)	22				
I _D (A) ^d	-13				
Configuration	Single				

ORDERING INFORMATION

Package	SO-8			
Lead (Pb)-free	Si4835DDY-T1-E3			
Lead (Pb)-free and halogen-free	Si4835DDY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS}	±25	v	
	T _C = 25 °C		-13		
Continuous drain surrent (T 150 °C)	T _C = 70 °C] , [-10.5		
Continuous drain current ($T_J = 150 \text{ °C}$)	T _A = 25 °C		-8.7 ^{a, b}		
	T _A = 70 °C	1	-7.7 ^{a, b}	A	
Pulsed drain current	I _{DM}	-50	A		
Continuous source, drain diada surrant	T _C = 25 °C	- I _S	-4.6		
Continuous source-drain diode current	T _A = 25 °C		2 ^{a, b}		
Avalanche current		I _{AS}	-20		
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	20	mJ	
	T _C = 25 °C		5.6		
Maximum power dissipation	T _C = 70 °C		3.6	14/	
	T _A = 25 °C	P _D	2.5 ^{a, b}	- W	
	T _A = 70 °C	1 [1.6 ^{a, b}	1	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient ^{a, c}	t ≤ 10 s	R _{thJA}	39	50	°C M/	
Maximum junction-to-foot	Steady state	R _{thJF}	18	22	°C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 85 °C/W

d. Based on $T_C = 25 \ ^{\circ}C$

S09-0136-Rev. B, 02-Feb-09

1

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•			•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \ \mu\text{A}$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-31	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	5.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 100	nA	
7		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-5		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30	-	-	А	
	_	V _{GS} = -10 V, I _D = -10 A	-	0.0140	0.0180		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -7 A	-	0.0245	0.0300	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -10 A	-	23	-	S	
Dynamic ^b			•	•			
Input capacitance	C _{iss}		-	1960	-		
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	380	-	pF	
Reverse transfer capacitance	C _{rss}		-	325	-		
Total gate charge	Q _g -	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	43	65	_	
			-	22	33		
Gate-source charge	Q _{qs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_{D} = -10 A	-	6	-	nC	
Gate-drain charge	Q _{gd}		-	11	-		
Gate resistance	R _g	f = 1 MHz	0.3	1.3	2.5	Ω	
Turn-on delay time	t _{d(on)}		-	11	22		
Rise time	tr	V_{DD} = -15 V, R_L = 3 Ω	-	13	25		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	-	32	50		
Fall time	t _f		-	9	18		
Turn-on delay time	t _{d(on)}		-	44	70	ns	
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 3 \Omega$	-	100	160		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -5 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	28	50		
Fall time	t _f		-	15	30		
Drain-Source Body Diode Characteris	tics		•	•			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-4.6		
Pulse diode forward current	I _{SM}		-	-	-50	A	
Body diode voltage	V _{SD}	$I_{\rm S}$ = -2 A, $V_{\rm GS}$ = 0 V	-	-0.75	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	28	45	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -2 A, di/dt = 100 A/μs,	-	20	40	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	13	-		
Reverse recovery rise time	t _b	- ·		15	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

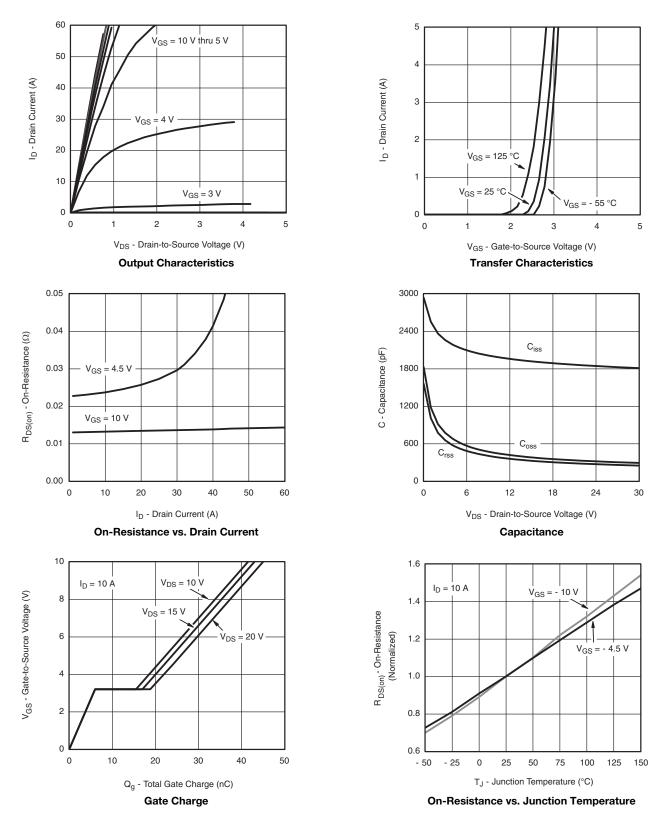
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



3

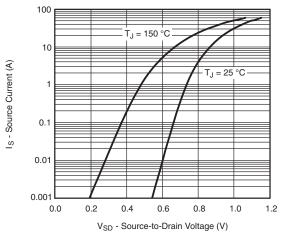
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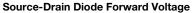


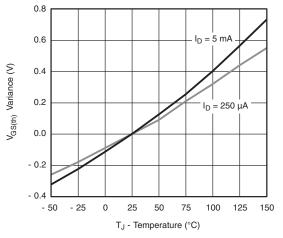
Si4835DDY

Vishay Siliconix

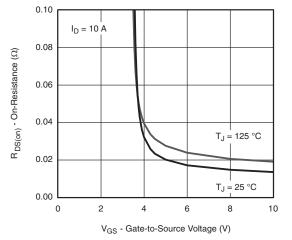
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



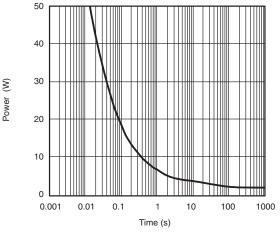




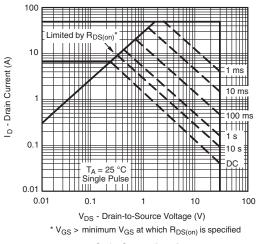




On-Resistance vs. Gate-to-Source Voltage







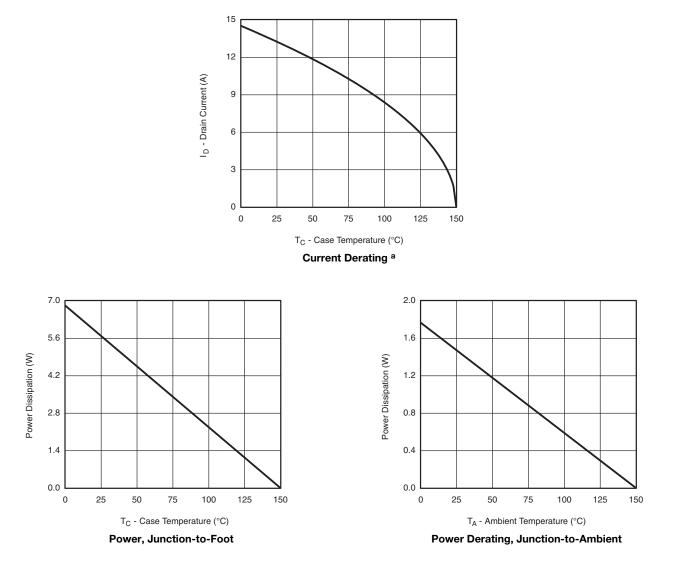
Safe Operating Area



Si4835DDY

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

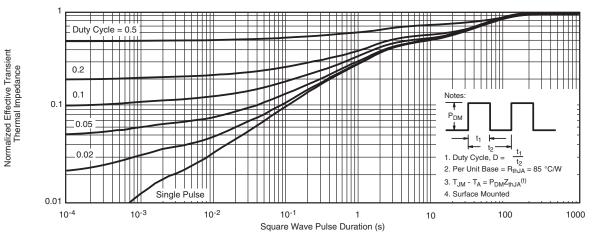


Note

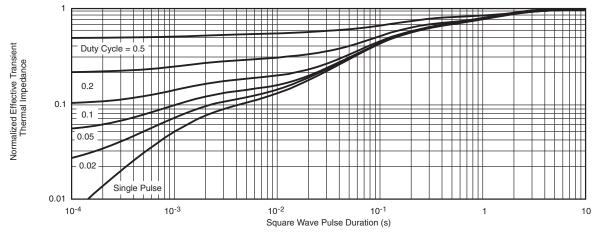
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



Vishay Siliconix



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69953.

6

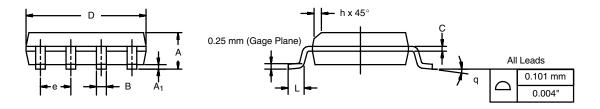


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	NCHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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